

LVPECL, LVDS Crystal Oscillator

Features

- 40 fs_{RMS} Phase Jitter Typical, 12 kHz to 20 MHz
- 3rd OT or Fundamental Crystal Design
- Extended Operating Temperature Range: –40°C to +125°C
- 100 MHz to 312.5 MHz Output Frequencies
- Excellent Power Supply Rejection Ratio
- · Glitch Free Output upon Power-Up and Enable
- Hermetically Sealed 7 mm x 5 mm Ceramic Package
- Product is Compliant to RoHS Directive and Fully Compatible with Lead-Free Assembly (Excluding Solder Dipped, _SNPB, Option)

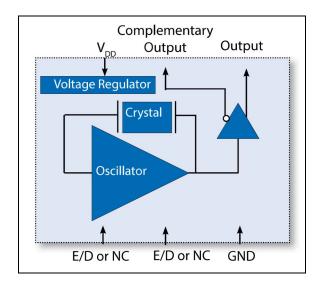
Applications

- · Medical, Ultrasound
- · Ethernet, GbE, SynchE
- · Fibre Channel
- PON
- · Clock Source for A/Ds, D/As, FPGAs
- · Test and Measurement
- · Storage Area Network

General Description

Microchip's VC-714 crystal oscillator is a quartz-stabilized, low phase jitter, differential output oscillator that is hermetically sealed in a 7 mm x 5 mm ceramic package.

Block Diagram



Phase Noise Plot

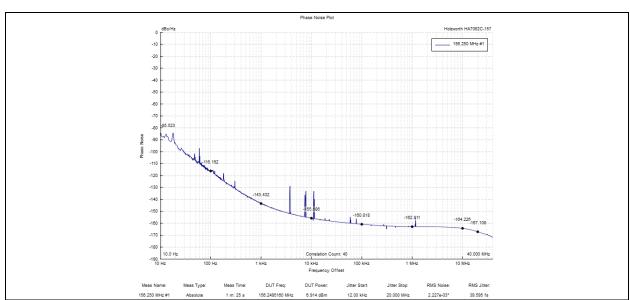


FIGURE 0-1: RMS Jitter, 40 fs_{RMS} at 156.25 MHz, over 12 kHz to 20 MHz.

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

| Supply Voltage | |
|---|------|
| Enable Disable Voltage | |
| ESD Rating, Human Body Model (Note 1) | 2 kV |
| ESD Rating, Charged Device Model (Note 1) | |
| Storage Temperature (T _S) | |
| Junction Temperature (T ₁) | |

† Notice: Stresses in excess of the Absolute Maximum Ratings can permanently damage the device. Functional operation is not implied at these or any other conditions in excess of conditions represented in the operational sections of this data sheet. Exposure to Absolute Maximum Ratings for extended periods may adversely affect device reliability.

Note 1: Although ESD protection circuitry has been designed into the VC-714, proper precautions should be taken when handling and mounting. Microchip employs a Human Body Model (HBM) and a Charged Device Model (CDM) for ESD susceptibility testing and design protection evaluation. ESD thresholds are dependent on the circuit parameters used to define the model. Although no industry standard has been adopted for the CDM, a standard resistance of 1.5 k Ω and capacitance of 100 pF is widely used and therefore can be used for comparison purposes.

ELECTRICAL CHARACTERISTICS, LVPECL OPTION

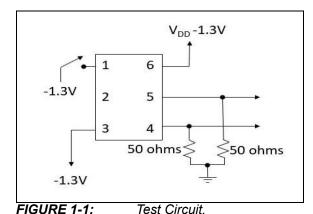
| Parameter | Sym. | Min. | Тур. | Max. | Units | Conditions | |
|------------------------------------|--------------------------------|----------------------------|--------------------------|----------------------------|-------|-------------------------|--|
| Sumply Valtage (Nate 4) | \/ | 2.375 | 2.5 | 2.625 | V | Ondersian Ontion | |
| Supply Voltage (Note 1) | V_{DD} | 3.135 | 3.3 | 3.465 | V | Ordering Option | |
| Current Consumption | I _{DD} | 1 | 1 | 70 | mA | _ | |
| Frequency | | | | | | | |
| Nominal Frequency | f_N | 100 | _ | 320 | MHz | Ordering Option | |
| | | _ | _ | ±25 | | | |
| Stability (Note 2) | _ | _ | _ | ±50 | ppm | Ordering Option | |
| | | _ | _ | ±100 | | | |
| Outputs | | | | | | | |
| Output Logic Level High (Note 3) | V_{OH} | V _{DD} – 1.085 | _ | V _{DD} – 0.860 | V | .0.57 | |
| Output Logic Level Low (Note 3) | V_{OL} | V _{DD} – 1.810 | | V _{DD} – 1.620 | V | V _{DD} = +2.5V | |
| Output Logic Level High (Note 3) | V _{OH} | V _{DD} – 1.085 | 1 | V _{DD} – 0.880 | V | V = 12.2V | |
| Output Logic Level Low (Note 3) | V _{OL} | V _{DD} – 1.810 | _ | V _{DD} – 1.620 | V | V _{DD} = +3.3V | |
| Output Rise and Fall Time (Note 3) | t _r /t _f | _ | _ | 400 | ps | _ | |
| Load | _ | 50Ω | into V _{DD} – 2 | 2.0V | _ | _ | |

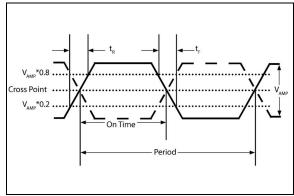
- Note 1: The VC-714 power supply should be filtered. For example, a 10 μF, 0.1 μF, and 0.01 μF capacitor.
 - 2: Includes calibration tolerance, operating temperature, supply voltage variations, aging, and IR reflow.
 - 3: Figure 1-1 defines the test circuit and Figure 1-2 defines these parameters.
 - 4: Duty Cycle is measured as On/Time Period.
 - 5: Measured using an Agilent E5052 Signal Source Analyzer at 25°C.
 - **6:** Outputs will be enabled if Enable/Disable is left open. There is an oscillation detection circuit that ensures glitch free output upon power-up or enable.
 - 7: In order to reduce current, the pull-up resistance is higher when V_{DD} is set to ground.

ELECTRICAL CHARACTERISTICS, LVPECL OPTION (CONTINUED)

| Parameter | Sym. | Min. | Тур. | Max. | Units | Conditions |
|--|-----------------|-----------------------|-------------|-----------------------|--------|-----------------|
| Duty Cycle (Note 4) | DC | 45 | _ | 55 | % | _ |
| | | _ | – 75 | _ | | 10 Hz |
| | | _ | -110 | _ | | 100 Hz |
| | | _ | -133 | _ | | 1 kHz |
| Phase Noise, 3.3V, 156.25 MHz | | _ | -141 | _ | dBc/Hz | 10 kHz |
| (Note 5) | φ _N | _ | -160 | _ | ubc/nz | 100 kHz |
| | | _ | -163 | _ | | 1 MHz |
| | | _ | -163 | _ | | 10 MHz |
| | | _ | -164 | _ | | 20 MHz |
| Phase Jitter, 156.25 MHz, 12 kHz to 20 MHz (Note 5) | фл | _ | 40 | 60 | fs | _ |
| Enable/Disable | | | | | | |
| Outputs Enabled (Note 6) | V _{IH} | 0.7 * V _{DD} | _ | _ | V | _ |
| Outputs Disabled | V_{IL} | _ | _ | 0.3 * V _{DD} | V | _ |
| Disable Time | t _D | _ | _ | 200 | ns | _ |
| E/D Pull-Up Resistance (Note 7) | _ | 0.5 | _ | 2 | ΜΩ | E/D = GND |
| E/D Pull-Up Resistance | _ | 30 | _ | 150 | kΩ | $E/D = V_{DD}$ |
| Start-Up Time | t _{SU} | _ | _ | 10 | ms | _ |
| | | -10 | _ | 70 | | |
| Operating Temperature | _ | -40 | _ | 85 | 00 | Ordering Ontion |
| Operating Temperature | T _{OP} | -40 | _ | 105 | °C | Ordering Option |
| | | -40 | | 125 | | |

- **Note 1:** The VC-714 power supply should be filtered. For example, a 10 μF, 0.1 μF, and 0.01 μF capacitor.
 - 2: Includes calibration tolerance, operating temperature, supply voltage variations, aging, and IR reflow.
 - 3: Figure 1-1 defines the test circuit and Figure 1-2 defines these parameters.
 - 4: Duty Cycle is measured as On/Time Period.
 - 5: Measured using an Agilent E5052 Signal Source Analyzer at 25°C.
 - **6:** Outputs will be enabled if Enable/Disable is left open. There is an oscillation detection circuit that ensures glitch free output upon power-up or enable.
 - 7: In order to reduce current, the pull-up resistance is higher when V_{DD} is set to ground.





ELECTRICAL CHARACTERISTICS, LVDS OPTION

| Parameter | Sym. | Min. | Тур. | Max. | Units | Conditions |
|--|--------------------------------|-------|--------------|-------|-------------|-----------------|
| | ., | 2.375 | 2.5 | 2.625 | ., | Ordering Option |
| Supply Voltage (Note 1) | V_{DD} | 3.135 | 3.3 | 3.465 | V | |
| | | | | 35 | | 2.5V |
| Current Consumption | I _{DD} | _ | _ | 35 | mA | 3.3V |
| Frequency | | | | | | |
| Nominal Frequency | f _N | 100 | _ | 320 | MHz | Ordering Option |
| | | _ | _ | ±25 | | |
| Stability (Note 2) | _ | _ | _ | ±50 | ppm | Ordering Option |
| | | _ | _ | ±100 | | |
| Outputs | | | | | | |
| Output Logic Level High (Note 3) | V _{OH} | _ | 1.43 | 1.6 | ., | |
| Output Logic Level Low (Note 3) | V _{OL} | 0.9 | 1.10 | _ | V | _ |
| Output Amplitude | _ | ±247 | ±350 | ±454 | mV | _ |
| Differential Output Error | _ | _ | _ | 50 | mV | _ |
| Offset Voltage | _ | 1.125 | 1.25 | 1.375 | V | _ |
| Offset Voltage Error | _ | _ | _ | 50 | mV | _ |
| Output Leakage Current, Outputs Disabled | _ | _ | _ | 30 | μA | _ |
| Output Rise and Fall Time (Note 3) | t _r /t _f | _ | _ | 300 | ps | _ |
| Load | _ | 10 | 0Ω Different | tial | _ | _ |
| Duty Cycle (Note 4) | DC | 45 | _ | 55 | % | _ |
| | | _ | -75 | _ | | 10 Hz |
| | | _ | -110 | _ | | 100 Hz |
| | | _ | -133 | _ | | 1 kHz |
| Phase Noise, 3.3V, 156.25 MHz | | _ | -141 | _ | -ID - /I I- | 10 kHz |
| (Note 5) | φ _N | _ | -158 | _ | dBc/Hz | 100 kHz |
| | | _ | -162 | _ | | 1 MHz |
| | | _ | -163 | _ | | 10 MHz |
| | | | -163 | _ | | 20 MHz |
| Phase Jitter, 156.25 MHz, 12 kHz to 20 MHz (Note 5) | фЈ | _ | 40 | 60 | fs | _ |

- Note 1: The VC-714 power supply should be filtered. For example, a 10 μF, 0.1 μF, and 0.01 μF capacitor.
 - 2: Includes calibration tolerance, operating temperature, supply voltage variations, aging, and IR reflow.
 - **3:** Figure 1-3 defines the test circuit and Figure 1-2 defines these parameters.
 - 4: Duty Cycle is measured as On/Time Period.
 - **5**: Measured using an Agilent E5052 Signal Source Analyzer at 25°C.
 - **6:** Outputs will be enabled if Enable/Disable is left open. There is an oscillation detection circuit that ensures glitch free output upon power-up or enable.
 - 7: In order to reduce current, the pull-up resistance is higher when $V_{\mbox{\scriptsize DD}}$ is set to ground.

ELECTRICAL CHARACTERISTICS, LVDS OPTION (CONTINUED)

| Parameter | Sym. | Min. | Тур. | Max. | Units | Conditions |
|---------------------------------|-----------------|-----------------------|------|-----------------------|-------|-----------------|
| Enable/Disable | | | | | | |
| Outputs Enabled (Note 6) | V_{IH} | 0.7 * V _{DD} | _ | _ | V | _ |
| Outputs Disabled | V_{IL} | _ | 1 | 0.3 * V _{DD} | V | _ |
| Disable Time | t _D | _ | 1 | 200 | ns | _ |
| E/D Pull-Up Resistance (Note 7) | 1 | 0.5 | 1 | 2 | ΜΩ | E/D = GND |
| E/D Pull-Up Resistance | 1 | 30 | 1 | 150 | kΩ | $E/D = V_{DD}$ |
| Start-Up Time | t _{SU} | _ | | 10 | ms | _ |
| | | -10 | 1 | 70 | | |
| On a setting Tarana a setting | _ | -40 | 1 | 85 | °C | |
| Operating Temperature | T _{OP} | -40 | _ | 105 | | Ordering Option |
| | | -40 | _ | 125 | | |

- Note 1: The VC-714 power supply should be filtered. For example, a 10 μF, 0.1 μF, and 0.01 μF capacitor.
 - 2: Includes calibration tolerance, operating temperature, supply voltage variations, aging, and IR reflow.
 - 3: Figure 1-3 defines the test circuit and Figure 1-2 defines these parameters.
 - 4: Duty Cycle is measured as On/Time Period.
 - 5: Measured using an Agilent E5052 Signal Source Analyzer at 25°C.
 - **6:** Outputs will be enabled if Enable/Disable is left open. There is an oscillation detection circuit that ensures glitch free output upon power-up or enable.
 - 7: In order to reduce current, the pull-up resistance is higher when $V_{\mbox{\scriptsize DD}}$ is set to ground.

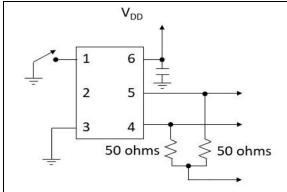


FIGURE 1-3: LVDS Test Circuit.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

| Pin Number | Pin Name | Description | | | |
|------------|-----------------|----------------------------------|--|--|--|
| 1 | E/D or NC | Enable/Disable or No Connection. | | | |
| 2 | E/D or NC | Enable/Disable or No Connection. | | | |
| 3 | GND | Electrical and lid ground. | | | |
| 4 | f _O | Output frequency. | | | |
| 5 | Cf _O | Complementary output frequency. | | | |
| 6 | V_{DD} | Supply voltage. | | | |

TABLE 2-2: ENABLE/DISABLE FUNCTION

| E/D Pin | Output | |
|---------|----------------|--|
| High | Clock Output | |
| Open | Clock Output | |
| Low | High Impedance | |

3.0 APPLICATION DIAGRAMS

3.1 LVPECL Application Diagrams

The VC-714 incorporates a standard PECL output scheme, which are unterminated FET drains. There are numerous application notes on terminating and interfacing PECL logic and the two most common methods are a single resistor to ground (Figure 3-1) and a pull-up/pull-down scheme as shown in Figure 3-2. AC-coupling capacitors are optional, depending on the application and the input logic requirements of the next stage.

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left unterminated because if one of the two outputs is left open, it will result in excessive jitter on both. PCB layout must take this and 50Ω impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

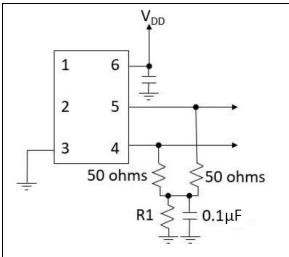


FIGURE 3-1: Pull-Down Resistor Termination Scheme.

Figure 3-1 shows one option to terminate LVPECL outputs and is optimized to reduce common mode noise. R1 is 50Ω for 3.3V supply voltage and 18Ω for 2.5V.

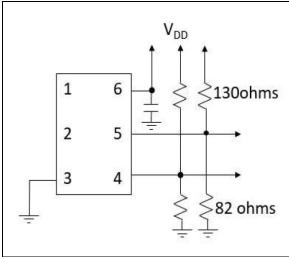


FIGURE 3-2: Pull-Up/Pull-Down Termination.

Resistor values shown are typical for 3.3V operation. For 2.5V operation, the resistor to ground is 62Ω and the resistor to supply is 250Ω . AC blocking capacitors can be used if the DC levels are incompatible.

3.2 LVDS Application Diagrams

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left unterminated because if one of the two outputs is left open, it will result in excessive jitter on both. PCB layout must take this and 50Ω impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

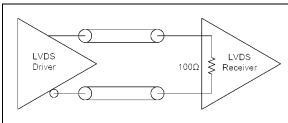


FIGURE 3-3: LVDS-to-LVDS Connection, Internal 100Ω Resistor.

Some LVDS structures have an internal 100Ω resistor on the input and do not need additional components. AC blocking capacitors can be used if the DC levels are incompatible.

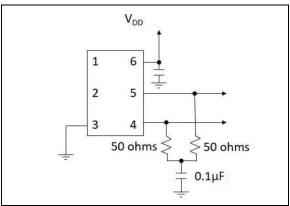


FIGURE 3-4: LVDS-to-LVDS Connection.

Some input structures may not have an internal 100Ω resistor on the input and will need an external 100Ω resistor for impedance matching. Also, the input may have an internal DC bias that may not be compatible with LVDS levels. AC blocking capacitors can be used.

4.0 RELIABILITY

Microchip qualification will include aging at various extreme temperatures, shock and vibration, temperature cycling, and IR reflow simulation. The VC-714 family is capable of meeting the following qualification tests.

TABLE 4-1: ENVIRONMENTAL COMPLIANCE

| Parameter | Conditions | | | |
|--------------------------------|---|--|--|--|
| Mechanical Shock | MIL-STD-883, Method 2002 | | | |
| Mechanical Vibration | MIL-STD-883, Method 2007 | | | |
| Temperature Cycle | MIL-STD-883, Method 1010 | | | |
| Solderability | MIL-STD-883, Method 2003 | | | |
| Gross and Fine Leak | MIL-STD-883, Method 1014 | | | |
| Resistance to Solvents | MIL-STD-883, Method 2015 | | | |
| Moisture Sensitivity Level | MSL 1 | | | |
| Contact Pads | Gold (0.3 μm min., 1.0 μm max.) over Nickel | | | |
| Contact Pads, _SNPB option | Tinned using solder alloy Sn63Pb37 in accordance with J-STD-006 | | | |
| θ_{JC} (Bottom of Case) | 30°C/W | | | |
| Maximum Junction Temperature | 150°C | | | |
| Weight | 180 mg | | | |

5.0 IR REFLOW

Devices are built using lead-free epoxy and can be subjected to standard lead-free IR reflow conditions shown in Table 5-1. Contact pads are gold over nickel and lower maximum temperatures can also be used, such as 220°C. **NOTE:** Devices which have been solder dipped, _SNPB option, will not be Pb-Free.

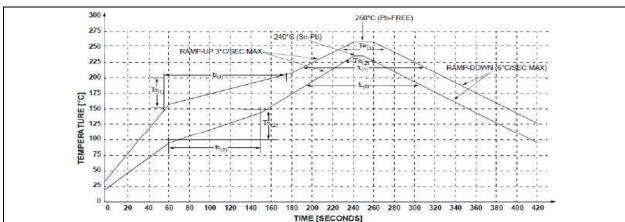


FIGURE 5-1: Solder Profile.

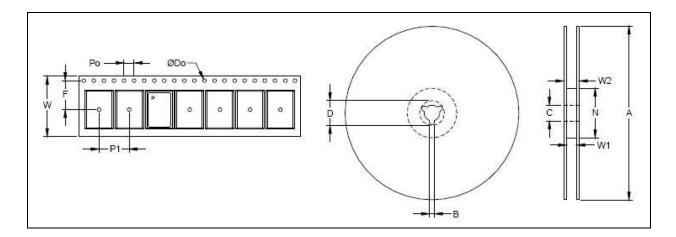
TABLE 5-1: REFLOW PROFILE

| Symbol | Minimum | Maximum | Conditions |
|-------------------|---------|----------|--------------|
| T _{S(1)} | 200°C | 250°C | Pb-Free |
| T _{S(2)} | 100°C | 150°C | _SNPB Option |
| t _{S(1)} | 60 sec. | 240 sec. | Pb-Free |
| t _{S(2)} | 60 sec. | 120 sec. | _SNPB Option |
| t _{l(1)} | 60 sec. | 150 sec. | Pb-Free |
| t _{I(2)} | 60 sec. | 150 sec. | _SNPB Option |
| T _{p(1)} | 245°C | 260°C | Pb-Free |
| T _{p(2)} | 225°C | 240°C | _SNPB Option |

6.0 TAPE AND REEL

TABLE 6-1: TAPE AND REEL DIMENSIONS

| | Tape Dimensions (mm) | | | | Reel Dimensions (mm) | | | | | | | | |
|-----------|----------------------|-----|-----|-----|----------------------|-----|-----|-----|-----|-----|-----|-----|-------|
| Dimension | W | F | Do | Ро | P1 | Α | В | С | D | N | W1 | W2 | # per |
| Tolerance | Тур | Тур | Тур | Тур | Тур | Тур | Тур | Тур | Тур | Тур | Тур | Max | Reel |
| VC-714 | 16 | 7.5 | 1.5 | 4 | 8 | 180 | 2 | 13 | 21 | 55 | 17 | 21 | 1000 |



7.0 PACKAGING INFORMATION

6-Lead 7 mm x 5 mm LDFN Package Outline and Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

Marking Information:

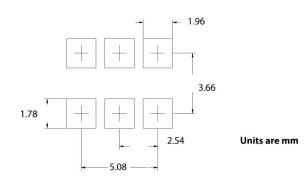
XXXMXX = Frequency (example: 100M00)

YY = Year of Manufacture

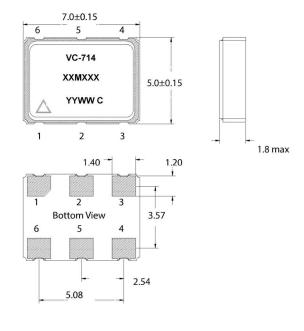
WW = Week of the Year

C = Manufacturing Location

= Pin 1 Indicator



Pad Layout



| \ / | | 7 | 1 | 1 |
|------------|---|----|---|---|
| V | U | -/ | | 4 |

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (May 2021)

- Converted Vectron document VC-714 to Microchip data sheet template DS20006509A.
- · Minor grammatical text changes throughout.

Revision B (August 2021)

 Added a plus/minus (±) symbol to each value listed for Output Amplitude in the Electrical Characteristics, LVDS Option table.

Revision C (July 2022)

- Added "_SNPB= Tin Lead Solder Dipped" packaging type information to the Product Identification System page.
- Replaced Figure 5-1 and Table 5-1 with current data.
- · Minor text and image corrections where needed.

| \/ | \frown | 7 | 4 | 1 |
|----|----------|----|---|---|
| V | U | -/ | | 4 |

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>X</u> -XXXXXXXXX **Device** -<u>X</u> X -<u>X</u> <u>X</u> X X <u>XX</u> Part No. Power Output Temp. Stability E/D Logic E/D Pin Custom Frequency Packaging Supply Range Options **Examples:** VC-714: LVPECL, LVDS Crystal Oscillator in Device: 6-Lead 7 mm x 5 mm LDFN a) VC-714-ECE-FAAN-200M000000TR: VC-714, 3.3VDC, LVPECL Output, -40°C to +85°C Temp Range, ±25 ppm Stability, 3.3VDC ±5% **Power Supply:** Output Enabled, Pin 1 Enable/Disable, 2.5VDC ±5% Standard Option, 200 MHz, 1000/Reel b) VC-714-HDW-KAAN-125M000000TR: **LVPECL** С = Output: VC-714, 2.5VDC, LVDS Output, -10°C to LVDS +70°C Temp Range, ±50 ppm Stability, Output Enabled, Pin 1 Enable/Disable, Е -40°C to +85°C Standard Option, 125 MHz, 1000/Reel Temperature F -40°C to +105°C Range: G = -40°C to +125°C -10°C to +70°C Tape and Reel identifier only appears in the Note 1: catalog part number description. This identifier is used for ordering purposes and is not printed on Ε ±20 ppm the device package. Check with your Microchip ±25 ppm Sales Office for package availability with the Stability: Κ ±50 ppm Tape and Reel option. ±100 ppm Enable/Disable Output Enabled with a Logic High or Open Α Logic: Ν No E/D Pin 1 (Pin 2 = No Connect) Enable/Disable Pin 2 (Pin 1 = No Connect) В = No Enable/Disable (Pin 1/2 No Connect) Χ Custom Standard option Options: Frequency: xxxMxxxxxx=Frequency in MHz TR = 1,000/Reel Packaging: <blank>= Cut Tape/ non-TR quantities _SNPB= Tin Lead Solder Dipped

Note: Not all combinations of options are available. Other specifications may be available upon request.

TABLE 1: STANDARD OUTPUT FREQUENCIES

| 100.000 MHz | 125.000 MHz | 156.250 MHz | 160.000 MHz | 200.000 MHz | 312.500 MHz |
|-------------|-------------|-------------|-------------|-------------|-------------|

| \/ | \frown | 7 | 1 | 1 |
|----|----------|----|---|---|
| V | U | -/ | | 4 |

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